



Product data sheet

1. General description

AC Thyristor power switch in a SOT223 surface-mountable plastic package with self-protective capabilities against low and high energy transients.

2. Features and benefits

- · Common terminal on mounting base allows multiple ACTs on shared cooling pad
- Exclusive negative gate triggering
- Full cycle AC conduction
- High voltage capability
- · Remote gate separates the gate driver from the effects of the load current
- · Safe clamping of low energy over-voltage transients
- · Self-protective turn-on during high energy voltage transients
- Surface-mountable package
- Very high noise immunity

3. Applications

- · Fan motor circuits
- Pump motor circuits
- · Lower-power highly inductive, resistive and safety loads
- · Contactors, circuit breakers, valves, dispensers and door locks

4. Quick reference data

Table 1. Q	uick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	-	800	V
$I_{T(RMS)}$	RMS on-state current	full sine wave; T _{sp} ≤ 112 °C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u>	-	-	0.8	A
I_{TSM}	non-repetitive peak on- state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; <u>Fig. 4; Fig. 5</u>	-	-	13	A
		full sine wave; T _{j(init)} = 25 °C; t _p = 16.7 ms	-	-	14.3	А
Tj	junction temperature		-	-	125	°C
V _{PP}	peak pulse voltage	T _j = 25 °C; non-repetitive, off-state; ten pulses on each voltage polarity; 20s or more between successive pulses; <u>Fig. 6</u>	-	-	2.5	kV

AC Thyristor power switch

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{LD+ G-};$ $T_{j} = 25 \text{ °C}; \frac{\text{Fig. 10}}{2}$	1	-	10	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ LD- G-};$ T _j = 25 °C; Fig. 10	1	-	10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 12</u>	-	-	20	mA
V _T	on-state voltage	I _T = 1.1 A; T _j = 25 °C; <u>Fig. 13</u>	-	-	1.3	V
V _{CL}	clamping voltage	I _{CL} = 0.1 mA; t _p = 1 ms; T _j = 25 °C	850	-	-	V
Dynamic	characteristics	-		-		
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (67% of V_{DRM}); exponential waveform; gate open circuit; Fig. 15	1000	-	-	V/µs
		V_{DM} = 402 V; T _j = 125 °C; exponential waveform; gate open circuit; Fig. 15	2000	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_{\text{D}} = 400 \text{ V}; \text{T}_{\text{j}} = 125 ^{\circ}\text{C}; \text{I}_{\text{T(RMS)}} = 0.8 \text{ A}; \\ \text{d} V_{\text{com}}/\text{d} \text{t} = 20 \text{ V}/\mu\text{s}; \text{ (snubberless condition); gate open circuit; } \\ \text{Fig. 16; Fig. 17}$	0.5	-	-	A/ms

5. Pinning information

Fable 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	LD	load						
2	СМ	common						
3	G	gate		G —o[≓→				
4	СМ	common		СМ 001аај924				

6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
ACT108W-800E	SOT223	ACT108W-800EF	Reel	4000	SOT223	16-Mar-2006		

7. Marking

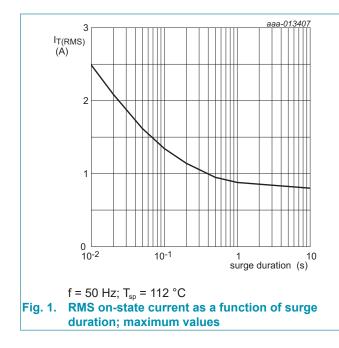
Table 4. Marking codes							
Type number	Marking codes						
ACT108W-800E	108W8E						

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	800	V
$I_{T(RMS)}$	RMS on-state current	full sine wave; T _{sp} ≤ 112 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	-	0.8	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; $T_{j(init)}$ = 25 °C; t_p = 20 ms; Fig 4; Fig 5	-	13	A
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms	-	14.3	А
l ² t	l ² t for fusing	t _p = 10 ms; SIN	-	0.84	A ² s
dl _T /dt	rate of rise of on-state current	I _G = 20 mA	-	100	A/µs
I _{GM}	peak gate current	t = 20 µs	-	1	А
V_{GM}	peak gate voltage	positive applied gate voltage	-	15	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	150	°C
T _j	junction temperature		-	125	°C
V_{PP}	peak pulse voltage	T _j = 25 °C; non-repetitive, off-state; ten pulses on each voltage polarity; 20s or more between successive pulses; <u>Fig. 6</u>	-	2.5	kV



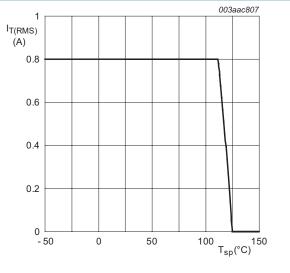
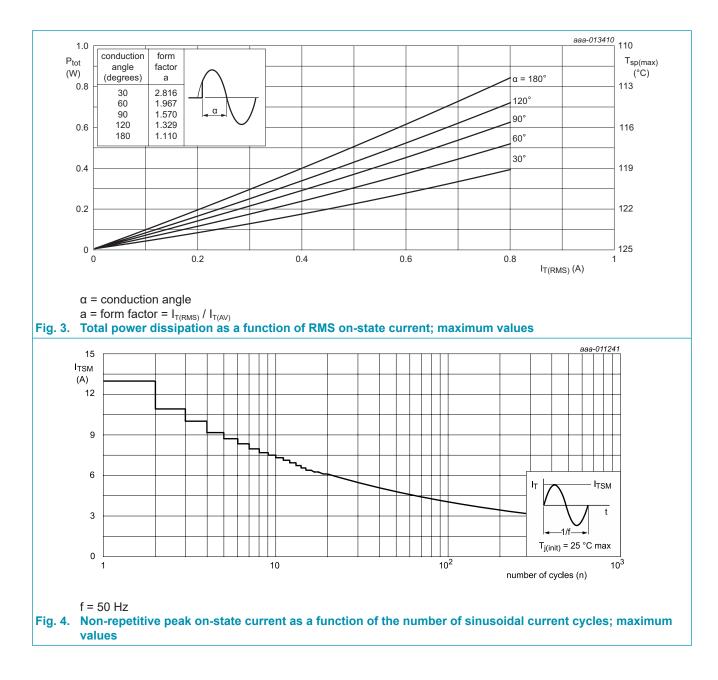
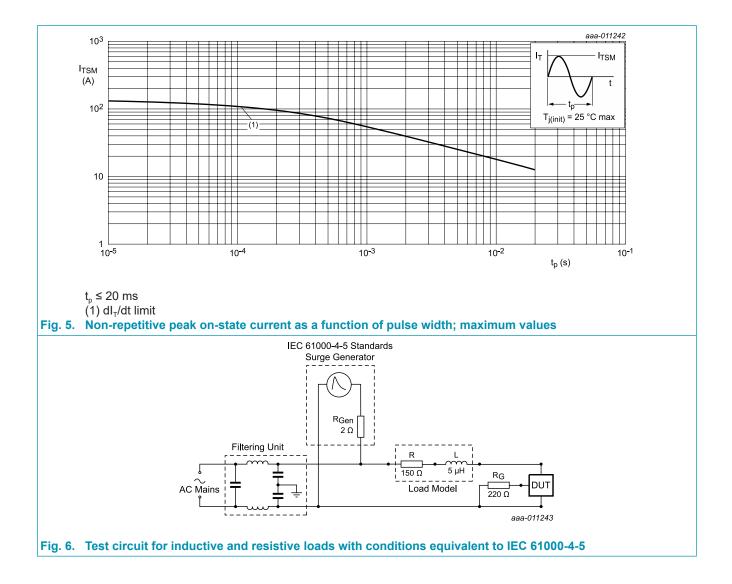


Fig. 2. RMS on-state current as a function of solder point temperature; maximum values

AC Thyristor power switch

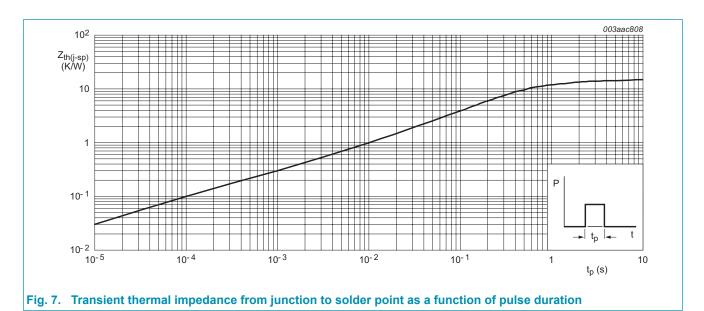


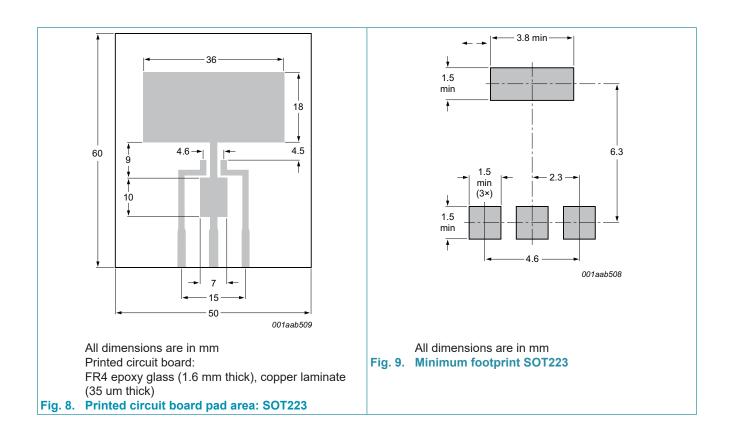
AC Thyristor power switch



9. Thermal characteristics

Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	full cycle with heatsink compound; Fig. 7	-	-	15	K/W
$R_{th(j-a)}$	thermal resistance from junction to	in free air; printed circuit board mounted: minimum pad area; <u>Fig. 8</u>	-	70	-	K/W
	ambient free air	in free air; printed circuit board mounted: minimum footprint; <u>Fig. 9</u>	-	156	-	K/W

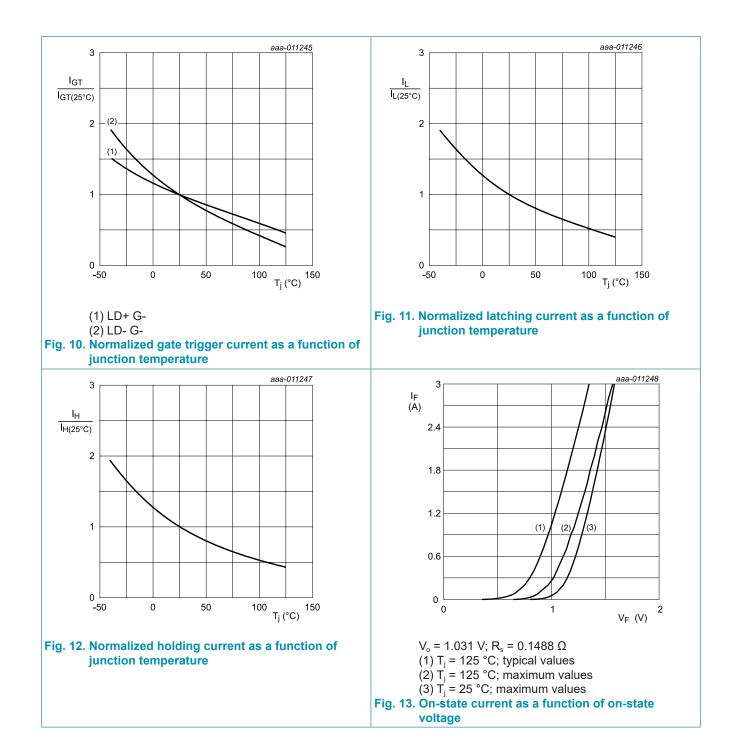




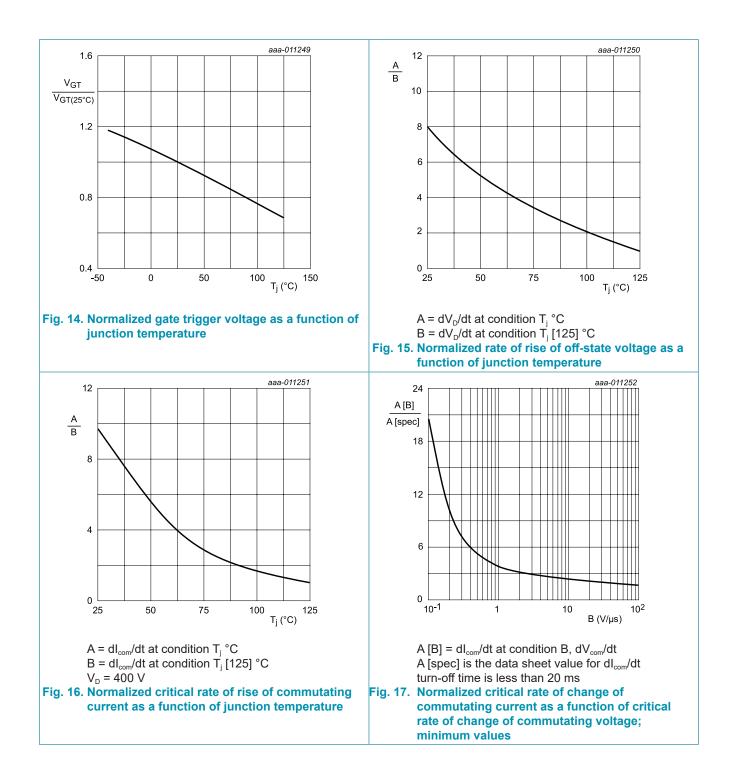
10. Characteristics

Symbol	Parameter	Conditions	I	Min	Тур	Max	Unit
Static cha	racteristics						
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; LD+ G-; T _j = 25 °C; <u>Fig. 10</u>		1	-	10	mA
		V _D = 12 V; I _T = 0.1 A; LD- G-; T _j = 25 °C; <u>Fig. 10</u>		1	-	10	mA
IL	latching current	V _D = 12 V; I _G = 0.1 A; LD+ G-; T _j = 25 °C; <u>Fig. 11</u>	-	-	-	25	mA
		V _D = 12 V; I _G = 0.1 A; LD- G-; T _j = 25 °C; <u>Fig. 11</u>	-	-	-	20	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 12</u>	-	-	-	20	mA
V _T	on-state voltage	I _T = 1.1 A; T _j = 25 °C; <u>Fig. 13</u>	-	-	-	1.3	V
V_{GT}	gate trigger voltage	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T}_{j} = 25 \text{ °C};$ Fig. 14	-	-	-	1	V
		V _D = 400 V; I _T = 0.1 A; T _j = 125 °C	(0.15	-	-	V
I _D	off-state current	V _D = 800 V; T _j = 25 °C	-	-	-	10	μA
		V _D = 800 V; T _j = 125 °C	-	-	-	2	mA
V _{CL}	clamping voltage	I _{CL} = 0.1 mA; t _p = 1 ms; T _j = 25 °C	8	850	-	-	V
Dynamic	characteristics						
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (67% of V_{DRM}); exponential waveform; gate open circuit; Fig. 15		1000	-	-	V/µs
		V_{DM} = 402 V; T _j = 125 °C; exponential waveform; gate open circuit; Fig. 15	2	2000	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 0.8 \text{ A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ (snubberless condition); gate open circuit;}$ Fig. 16; Fig. 17	(0.5	-	-	A/ms

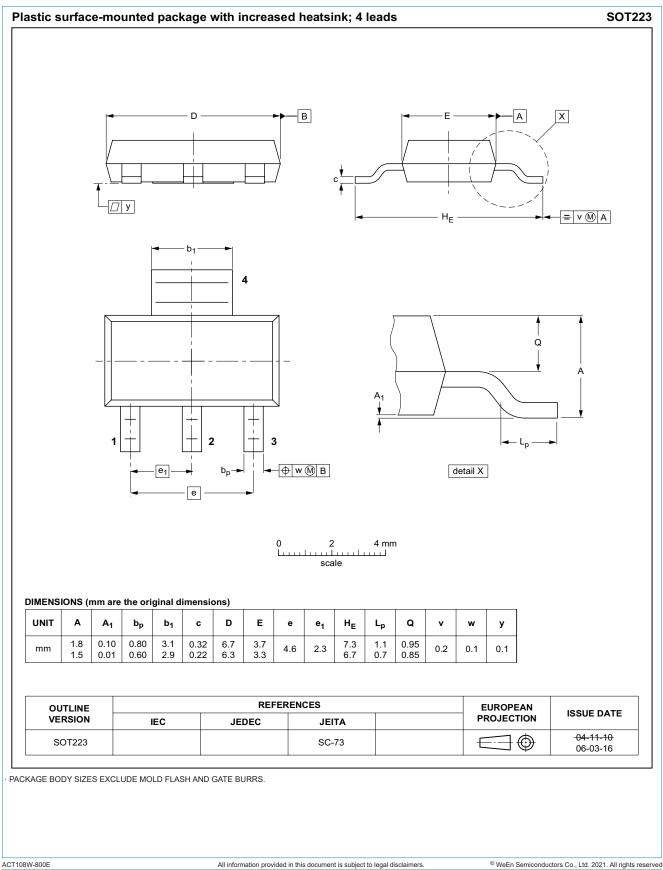
ACT108W-800E AC Thyristor power switch



ACT108W-800E AC Thyristor power switch



11. Package outline



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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